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(12) **United States Design Patent**
Chiu et al.

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(54) **HEADSET**

(71) Applicant: **Logitech Europe S.A.**, Lausanne (CH)

(72) Inventors: **Chi Tat Chiu**, Hong Kong (HK);
Ricardo Filipe Figueiroa Monteiro,
San Francisco, CA (US)

(73) Assignee: **Logitech Europe S.A.**, Lausanne (CH)

(**) Term: **15 Years**

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Related U.S. Application Data

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Mar. 24, 2023, now Pat. No. Des. 1,060,304.

(51) **LOC (15) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
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381/380–381, 374; D28/41;
132/274–275
CPC H04R 25/00; H04R 25/02; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
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H04R 1/1091
See application file for complete search history.

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Primary Examiner — Paula Allen Greene

(74) *Attorney, Agent, or Firm* — Kilpatrick Townsend &
Stockton LLP

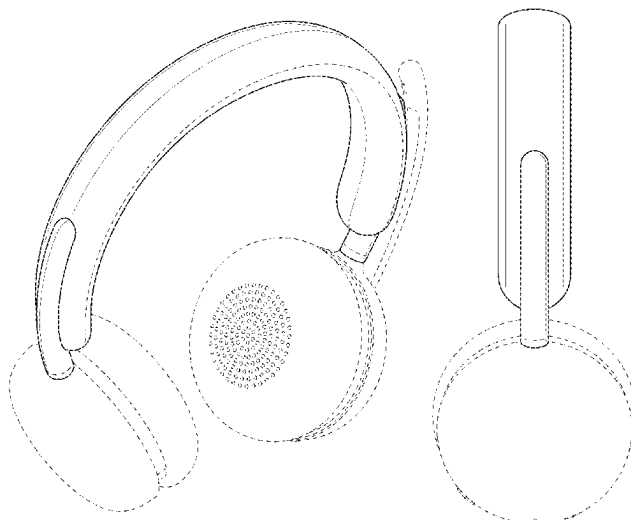
(57) **CLAIM**

The ornamental design for a headset as shown and
described.

DESCRIPTION

FIG. 1 is a front perspective view of a headset showing our
new design;
FIG. 2 is a bottom perspective view thereof;
FIG. 3 is a top plan view thereof;
FIG. 4 is a bottom plan view thereof;
FIG. 5 is a rear elevation view thereof;
FIG. 6 is a front elevation view thereof;
FIG. 7 is a right-side elevation view thereof; and,
FIG. 8 is a left-side elevation view thereof.
The broken lines on the side of the headband of the headset
represent an ornamental line that form no part of the claimed
design. The broken lines immediately adjacent the shaded
areas represent the bounds of the claimed design while all
other broken lines are directed to unclaimed features that
form no part of the claimed design.

1 Claim, 6 Drawing Sheets



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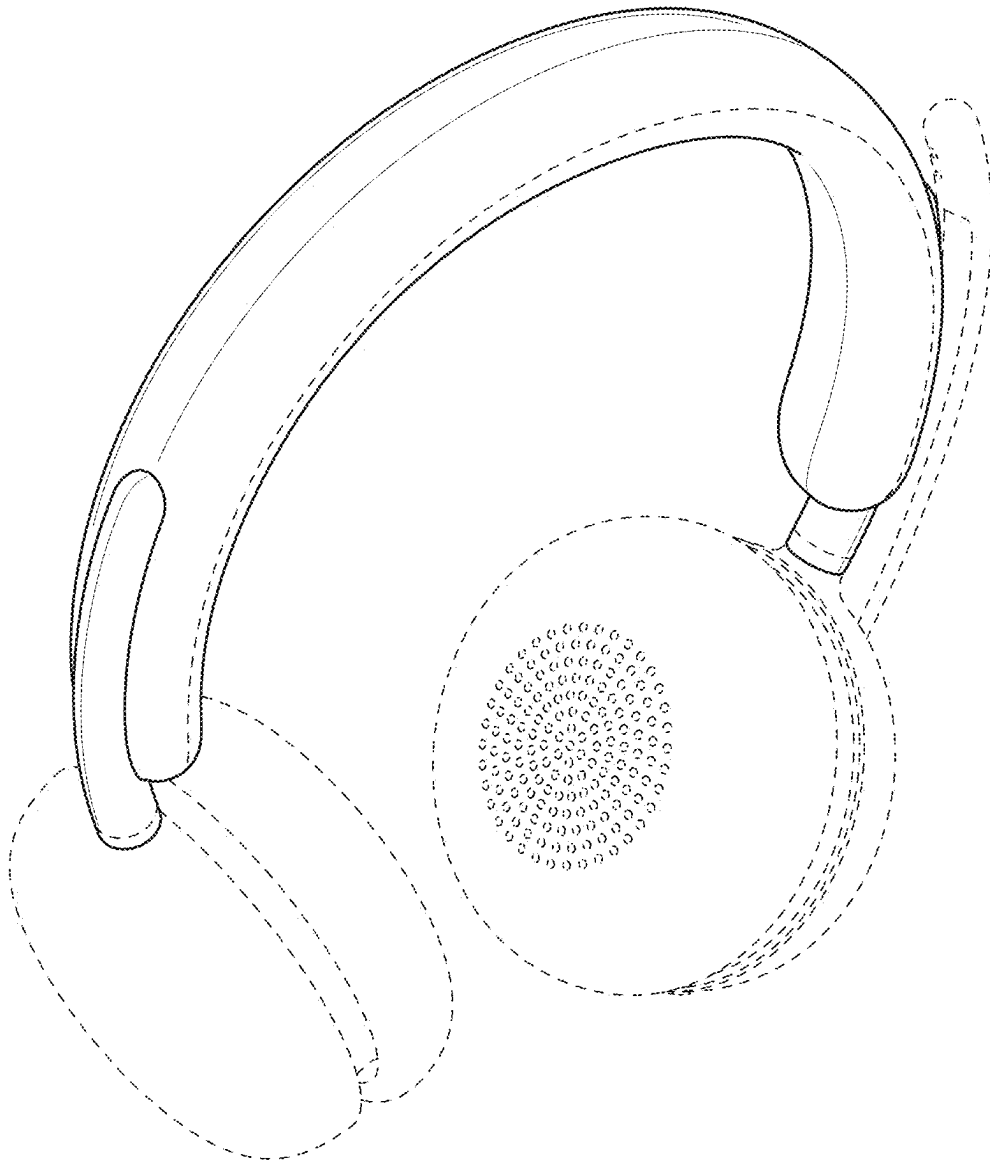


FIG. 1

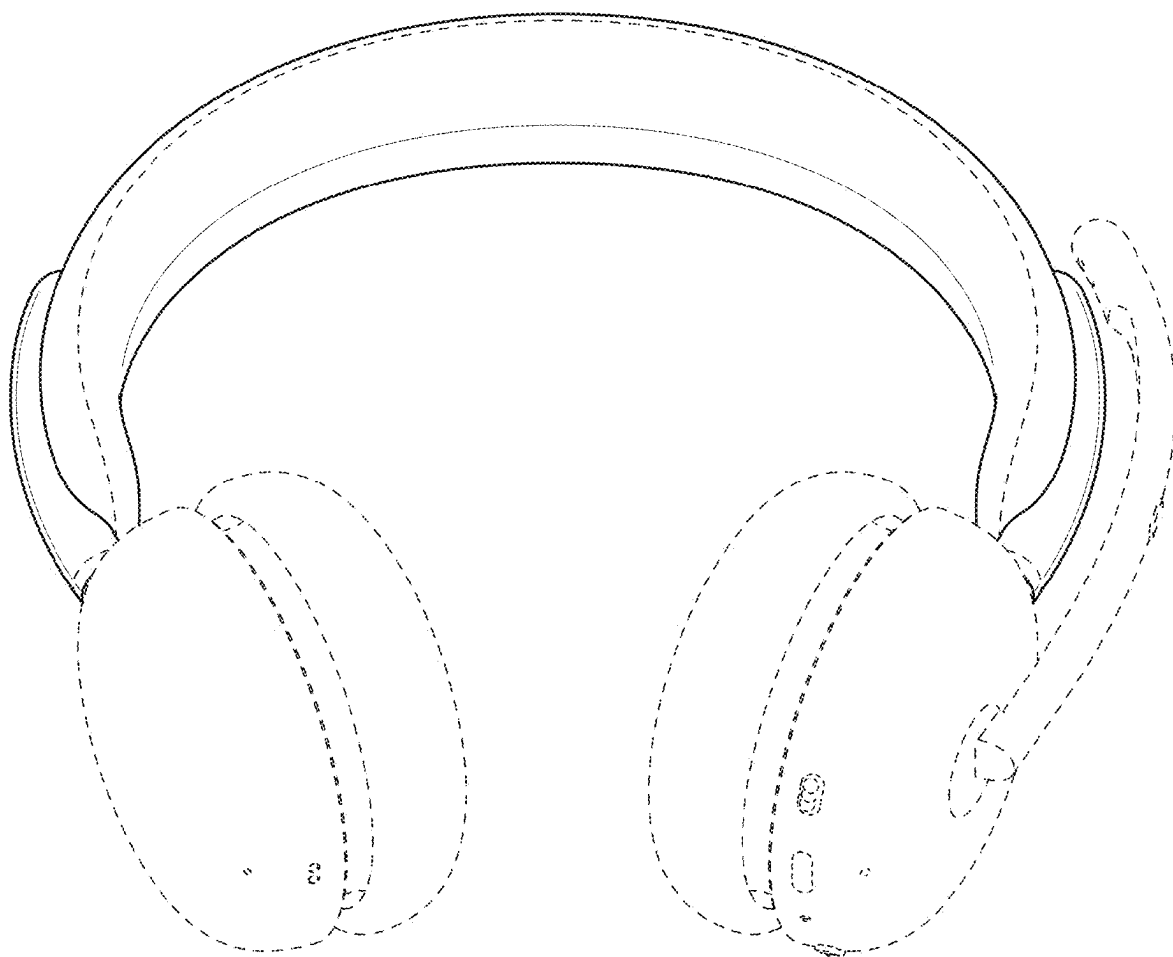


FIG. 2

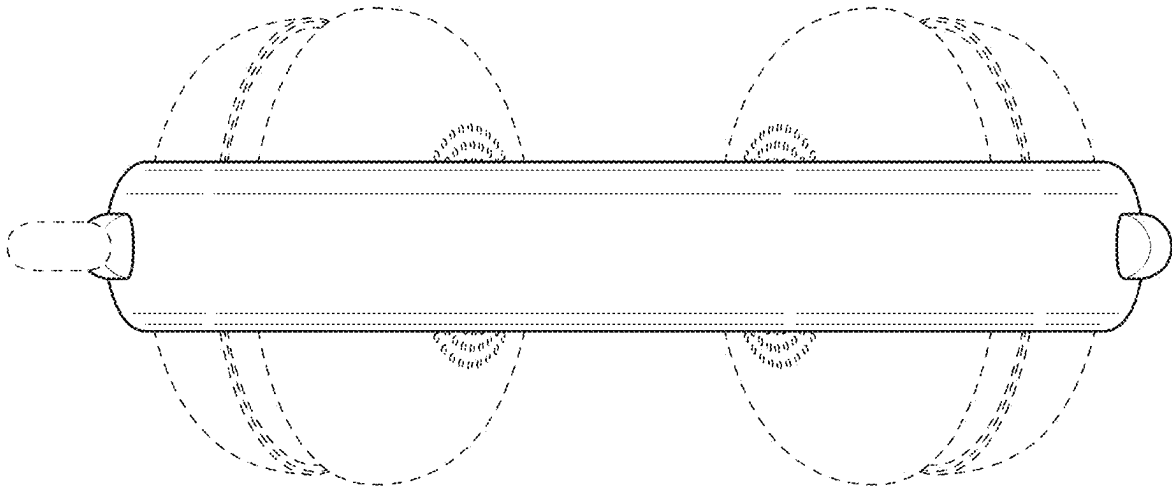


FIG. 3

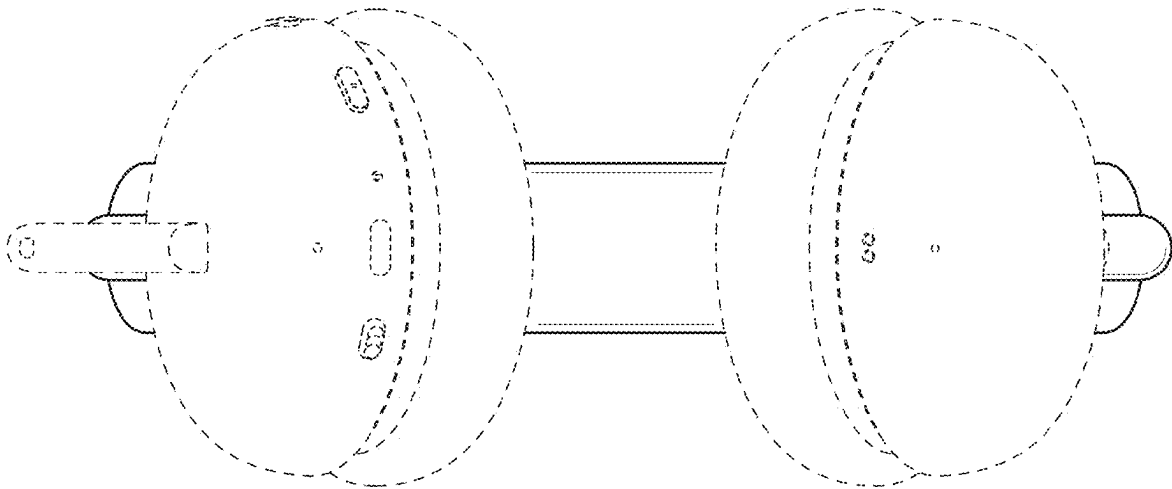


FIG. 4



FIG. 5



FIG. 6

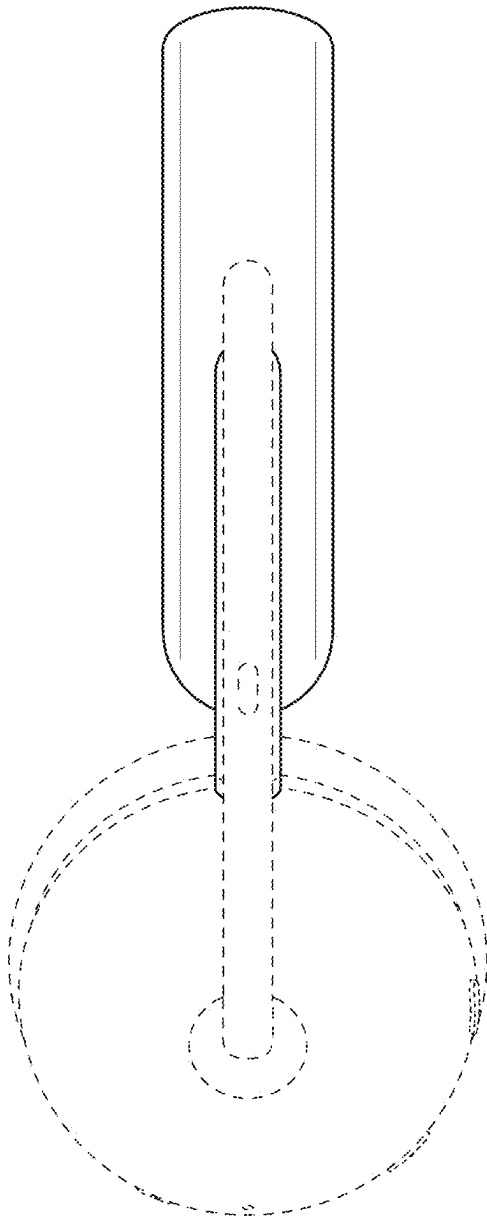


FIG. 7

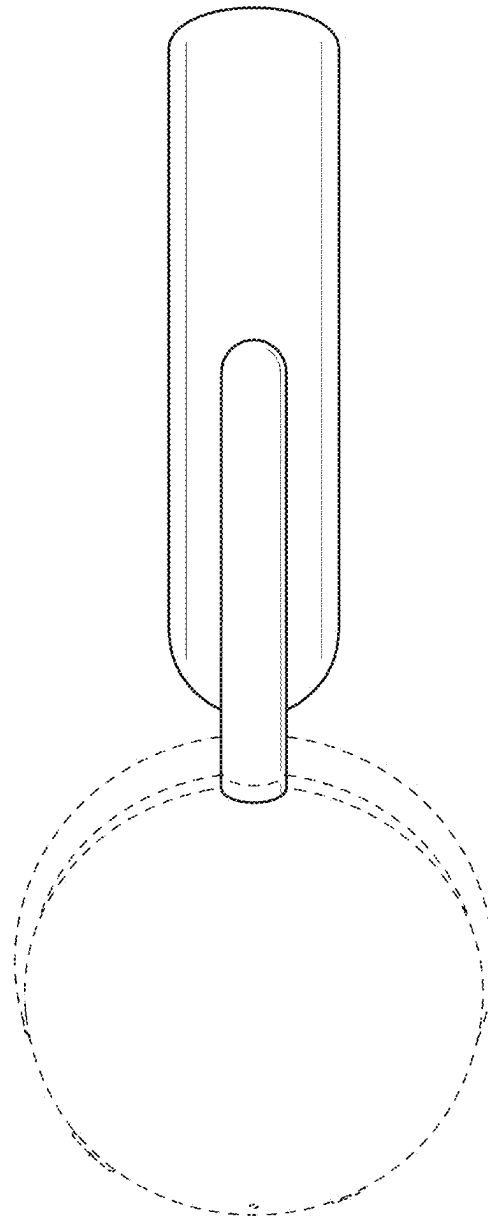


FIG. 8